JANUARY 1996



DS4142-3.3

DF252

FAST RECOVERY DIODE

APPLICATIONS

- Induction Heating.
- A.C. Motor Drives.
- Inverters And Choppers.
- Welding.
- High Frequency Rectification.
- UPS.

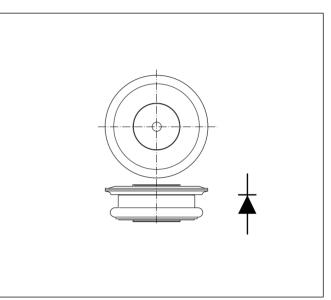
FEATURES

- Double Side Cooling.
- High Surge Capability.
- Low Recovery Charge.

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V _{RRM} V	Conditions
DF252 16	1600	$V_{RSM} = V_{RRM} + 100V$
DF252 14	1400	
DF252 12	1200	
DF252 10	1000	
DF252 08	800	
DF252 06	600	

KEY PARAMETERS V_{RRM} 1600V I_{F(AV)} 360A I_{FSM} 3000A Q_r 35μC t_{rr} 3.2μs



Outline type code: M771. Turn to page 8 for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units			
Double Side Cooled							
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	360	A			
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	560	A			
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	500	А			
Single Side Cooled (Anode side)							
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	276	A			
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	435	А			
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	375	А			

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SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 0% V _{RRM} T _i = 150°C	3.0	kA
l ² t	I ² t for fusing	Toms than sine, with 0 % V_{RRM} , $T_j = 150 C$	45 x 10 ³	A ² s
I _{FSM}	Surge (non-repetitive) forward current	10ms half sine; with 50% V _{RRM} T _i = 150°C	2.4	kA
l ² t	I ² t for fusing	$V_{\rm RRM}, V_j = 15000$	28.8 x 10 ³	A ² s

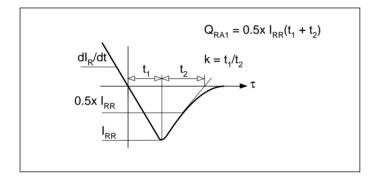
THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
R _{th(j-c)}	Thermal resistance - junction to case	Double side cooled	dc	-	0.07	°C/W
		Single side cooled	Anode dc	-	0.133	°C/W
			Cathode dc	-	0.147	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Clamping force 3.5kN with mounting compound	Double side	-	0.02	°C/W
			Single side	-	0.04	°C/W
T _{vj}	Virtual junction temperature	On-state (conducting)		-	150	°C
T _{stg}	Storage temperature range			-55	150	°C
-	Clamping force			3.0	4.0	kN

CHARACTERISTICS

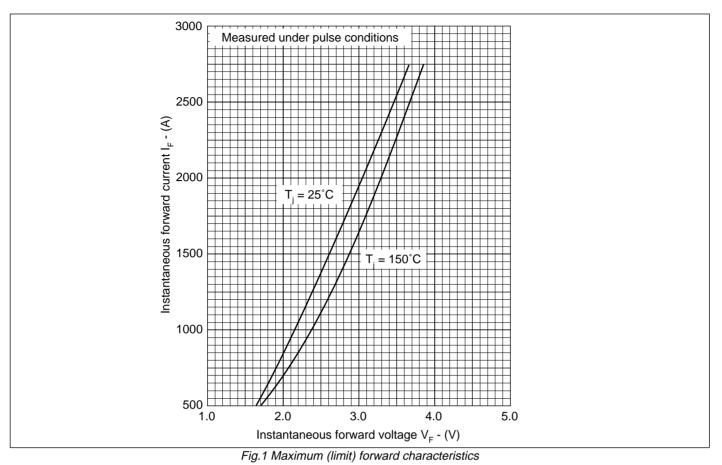
Symbol	Parameter	Conditions	Тур.	Max.	Units
V _{FM}	Forward voltage	At 450A peak, T _{case} = 25°C	-	1.6	V
I _{RRM}	Peak reverse current	At V_{RRM} , $T_{\text{case}} = 125^{\circ}\text{C}$	-	20	mA
t _{rr}	Reverse recovery time		3.2	-	μs
Q _{RA1}	Recovered charge (50% chord)	I _F = 750A, di _{RR} /dt = 100A/μs	-	35	μC
I _{RM}	Reverse recovery current	$T_{case} = 125^{\circ}C, V_{R} = 100V$	-	21	A
к	Soft factor		1.5	-	-
V _{TO}	Threshold voltage	At $T_{vj} = 150^{\circ}C$	-	1.0	V
r _T	Slope resistance	At T _{vj} = 150°C	-	1.33	mΩ
V _{frm}	Forward recovery voltage	di/dt = 1000A/µs, T _j = 125°C	-	50	V

DEFINITION OF K FACTOR AND \mathbf{Q}_{RA1}



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CURVES



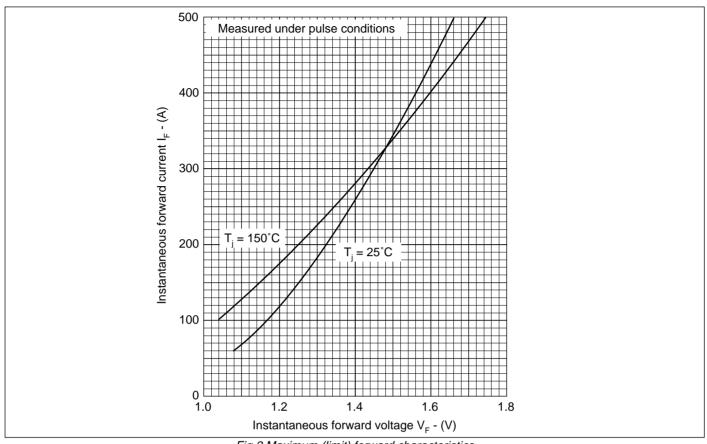
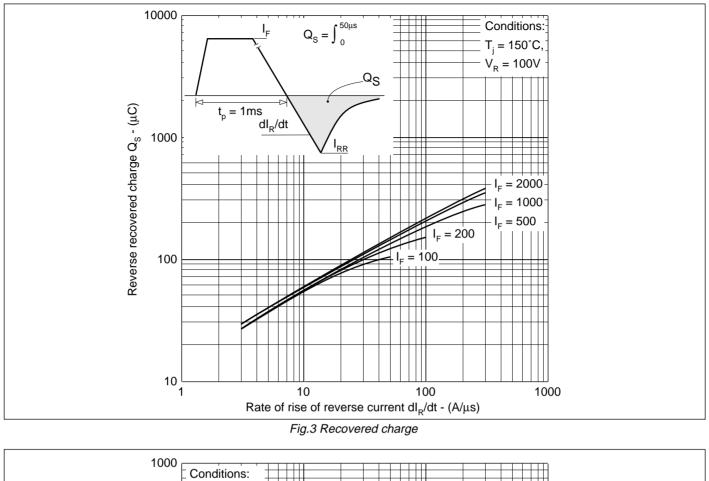
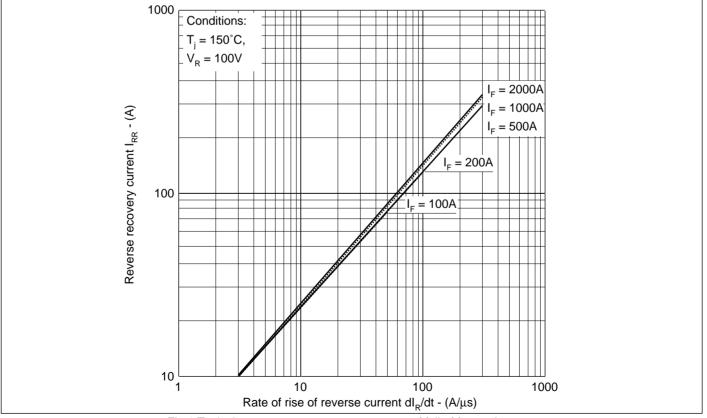


Fig.2 Maximum (limit) forward characteristics







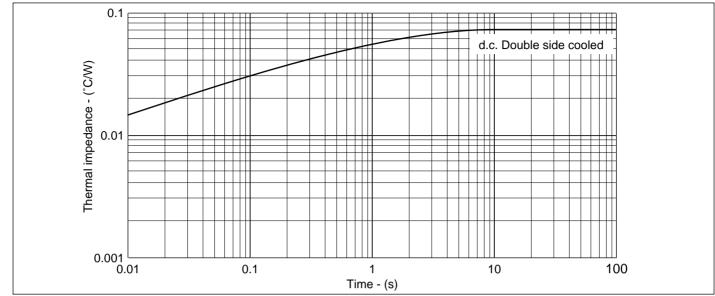
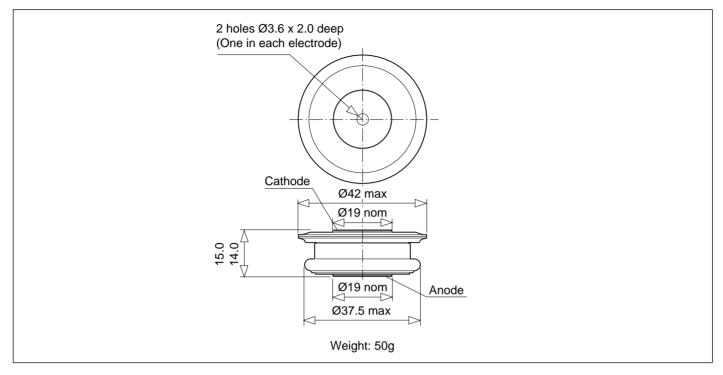


Fig.5 Maximum (limit) transient thermal impedance - junction to case - (°C/W)

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PACKAGE DETAILS - M771

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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